

# MP-5050-250R

## Mid Power LED



### Table of Contents

Technology Overview . . . . .	2
Product Selection Table . . . . .	3
Operating Characteristics . . . . .	4
Chromaticity Diagram . . . . .	5
Color Ranks . . . . .	5
Chromaticity Coordinate Group .....	6
Characteristics Graphs . . . . .	7
Ordering Nomenclature . . . . .	9
Package Dimensions . . . . .	10
Soldering Profile . . . . .	11
Package Dimensions of Reel .....	12
Inner Box . . . . .	13

### Features:

---

- High efficacy
- Sulfur resistance for outdoor and horticulture applications
- Low thermal resistance
- Compatible with automatic placement equipment
- Compatible with infrared reflow solder process
- RoHs and REACH compliant

### Applications

---

- Replacement lamps
- Panel lighting
- Down lights
- Architectural lighting

## Technology Overview

Luminus mid power LEDs are lighting class solutions designed for high performance general lighting applications. These state-of-the-art LEDs allow illumination engineers and designers to develop lighting solutions with maximum efficacy, brightness and overall quality.

### Reliability

Luminus mid power LED is one of the most reliable light sources in the world today. Having passed a rigorous suite of environmental and mechanical stress tests, including mechanical shock, vibration, temperature cycling and humidity, it is fully qualified for use in a wide range of high performance and high efficacy lighting applications.

### REACH & RoHS Compliance

The Luminus 5050 Mid Power LED is compliant to the Restriction of Hazardous Substances Directive or RoHS. The restricted materials including lead, mercury cadmium hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ether (PBDE) are not used.

## Understanding Luminus Mid Power LED Test Specifications

Every Luminus LED is fully tested to ensure it meets the high quality standards customers have come to expect from Luminus products.

### Testing Temperature

Luminus Mid Power products are measured at a case solder point temperature of 25°C and placed into intensity, chromaticity and voltage bins as described here in

**Product Selection Table**

Test condition  $I_f = 640$ ,  $T_s = 25$  °C

Nominal CCT	Minimum CRI	Ordering Part Number	Minimum Flux (Lumens)	Typical Flux (Lumens)
2700K	70	MP-5050-250R-27-70	600	640
	80	MP-5050-250R-27-80	560	610
	90	MP-5050-250R-27-90	480	520
3000K	70	MP-5050-250R-30-70	600	670
	80	MP-5050-250R-30-80	600	640
	90	MP-5050-250R-30-90	480	540
4000K	70	MP-5050-250R-40-70	650	705
	80	MP-5050-250R-40-80	600	680
	90	MP-5050-250R-40-90	520	585
5000K	70	MP-5050-250R-50-70	650	705
	80	MP-5050-250R-50-80	600	680
	90	MP-5050-250R-50-90	520	585
5700K	70	MP-5050-250R-57-70	650	705
	80	MP-5050-250R-57-80	600	680
	90	MP-5050-250R-57-90	520	585
6500K	70	MP-5050-250R-65-70	650	705
	80	MP-5050-250R-65-80	600	680
	90	MP-5050-250R-65-90	520	585

\*IFP condition with Pulse: Width  $\leq 100\mu s$  Duty cycle  $\leq 1/10$

\*Tolerance of measurements of the Luminous Flux is  $\pm 7\%$

\*Ra measurement tolerance is  $\pm 2$

\*Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram

**5050 Mid Power Operating Characteristics**

**Optical and Electrical Characteristics ( $T_s=25^\circ\text{C}$ )**

Parameter	Symbol	Minimum	Typical	Maximum	Unit	Condition
Forward Voltage	$V_f$	5.6	5.95	6.4	V	$I_f=640\text{mA}$
Reverse Current	$I_r$			10	$\mu\text{A}$	$V_r=5\text{V}$
View Angle	$2\theta^{1/2}$		120		$^\circ$	$I_f=640\text{mA}$
Thermal Resistance	$R_{th_{j-sp}}$		2.1		$^\circ\text{C/W}$	$I_f=640\text{mA}$
Electrostatic Discharge	ESD	1000			V	HBM

Note 1: To prevent damage refer to operating conditions and derating curves for appropriate maximum operating conditions

Note 2: Maximum operating case temperature combined with maximum drive current defines the total maximum operating condition for the device. To prevent damage, please follow derating curves for all operating conditions.

Note 3: Mid power LEDs are designed for operation up to an absolute maximum forward drive current as specified above. Product lifetime data is specified at typical forward drive currents. Sustained operation at absolute maximum currents will result in a reduction of device lifetime compared to typical forward drive currents. Actual device lifetimes will also depend on case temperature. Refer to the current vs. case temperature derating curves for further information.

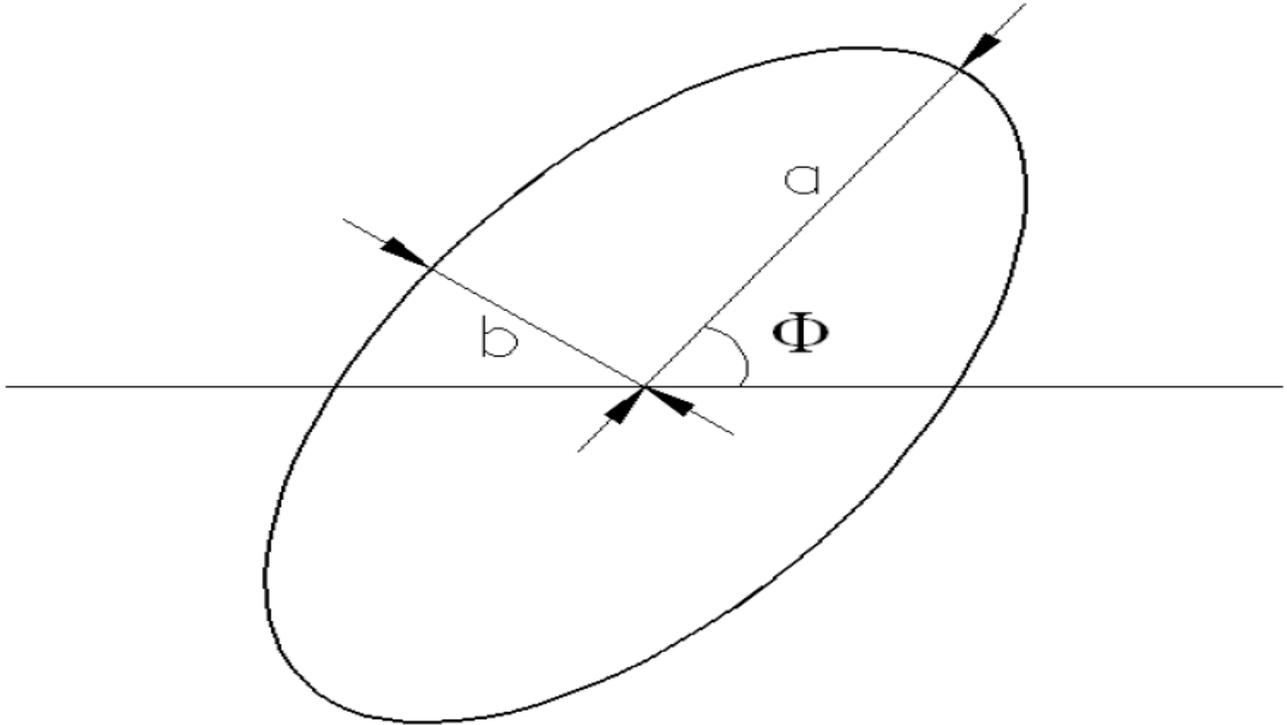
Note 4: Caution must be taken not to stare at the light emitted from these LEDs. Under special circumstances, the high intensity could damage the eye.

**Absolute Maximum Ratings ( $T_s=25^\circ\text{C}$ )**

Parameter	Symbol	Rating	Unit
Forward Current	$I_f$	1000	mA
Pulse Forward Current	$I_{fp}$	1200	mA
Power Dissipation	$P_d$	6600	mW
Reverse Voltage	$V_r$	5	V
Operating Temperature	$T_{opr}$	-40~+105	$^\circ\text{C}$
Storage Temperature	$T_{sta}$	-40~+85	$^\circ\text{C}$
Junction Temperature	$T_j$	120	$^\circ\text{C}$
Soldering Temperature	$T_{sld}$	230 $^\circ\text{C}$ or 260 $^\circ\text{C}$ for 10 sec	

\*IFP condition with Pulse: Width  $\leq 100\mu\text{s}$  Duty cycle  $\leq 1/10$

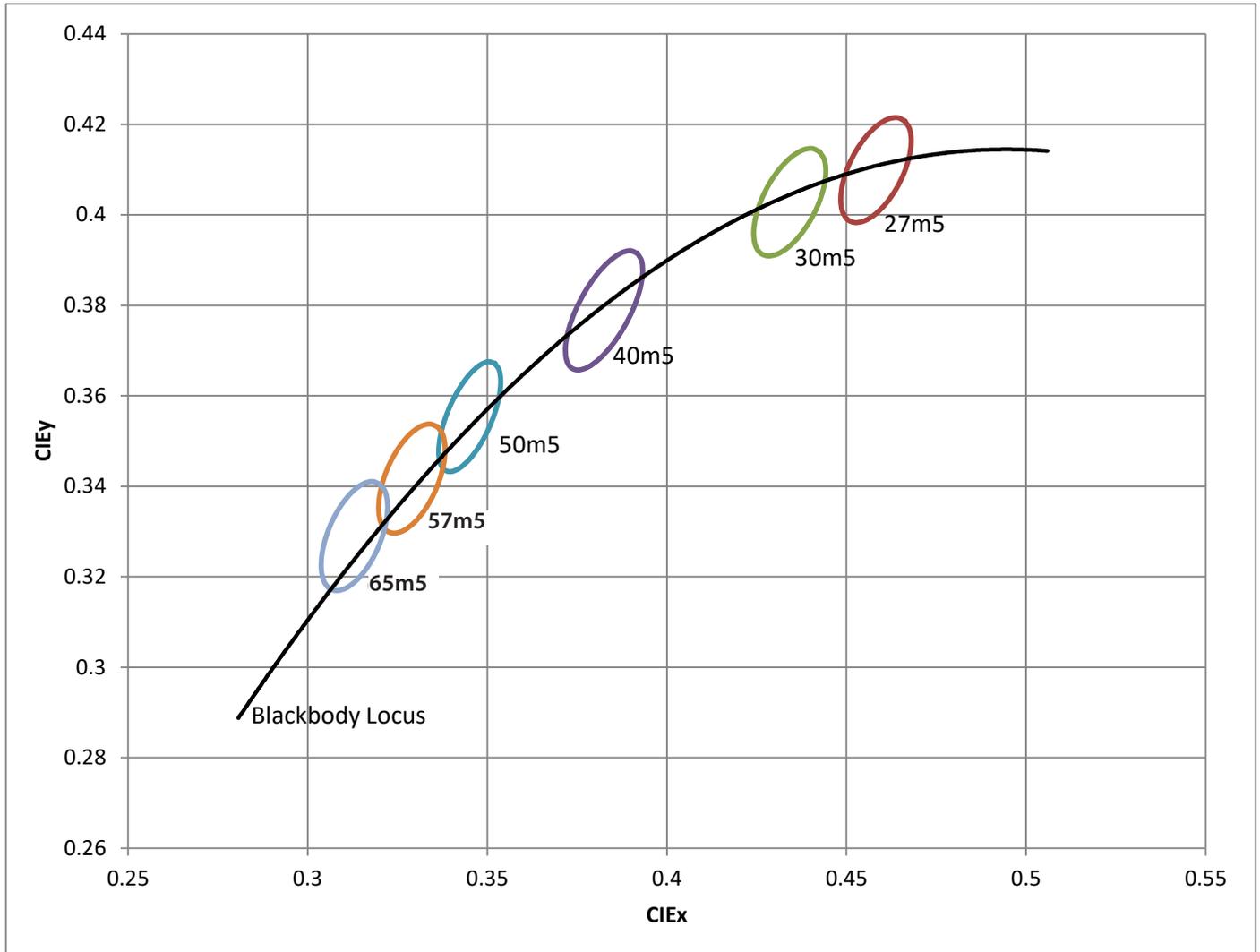
### Chromaticity Diagram



### Color Bins

Color Code	Center		Radius		Angle(deg)
	x	y	a	b	
27m5	0.4582	0.4099	0.0135	0.007	53.42
30m5	0.4342	0.4028	0.0139	0.0068	53.13
40m5	0.3825	0.3798	0.01565	0.0067	53.43
50m5	0.3451	0.3554	0.0137	0.0059	59.37
57m5	0.329	0.3417	0.011175	0.0055	58.35
65m5	0.313	0.329	0.01115	0.00475	58.34

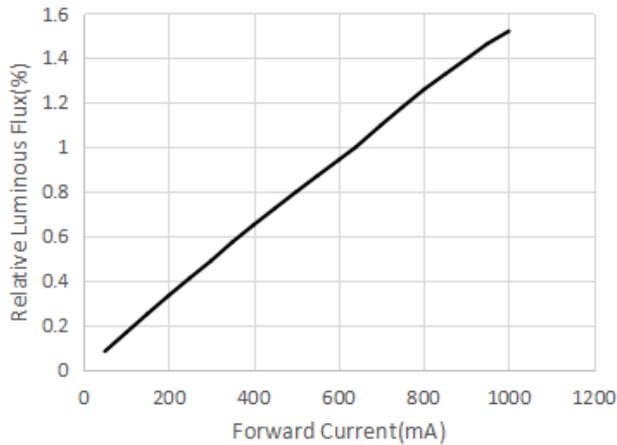
\*Note: Tolerance of measurements of the chromaticity Coordinate is  $\pm 0.005$   
 Chromaticity coordinates as per ANSI standard.

**Chromaticity Coordinate Group**


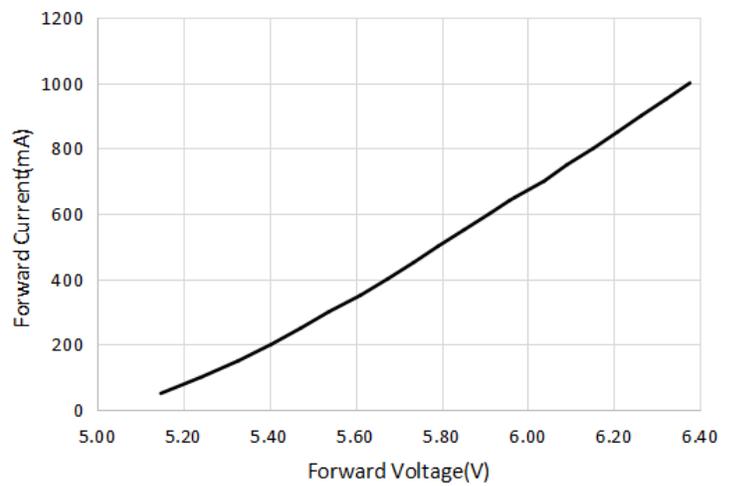
\*Note: Luminus maintains a +/- 0.01 tolerance on chromaticity (CIEx and CIEy) measurements.

Typical Optical/Electrical Characteristics Graphs

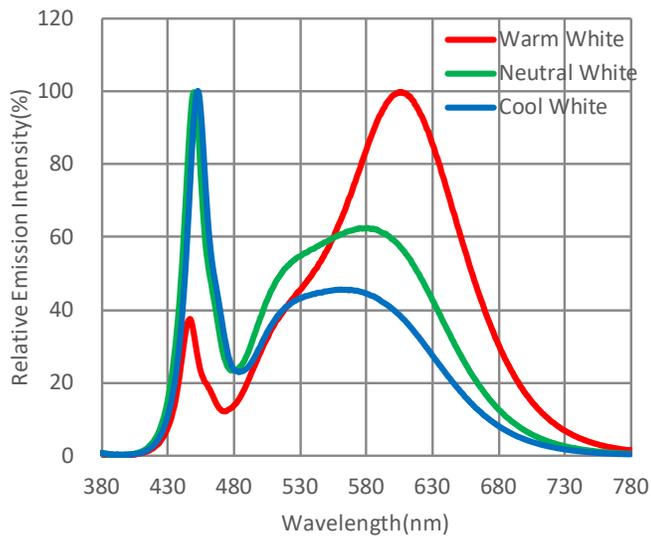
$I_f$ ---- Relative Luminous flux



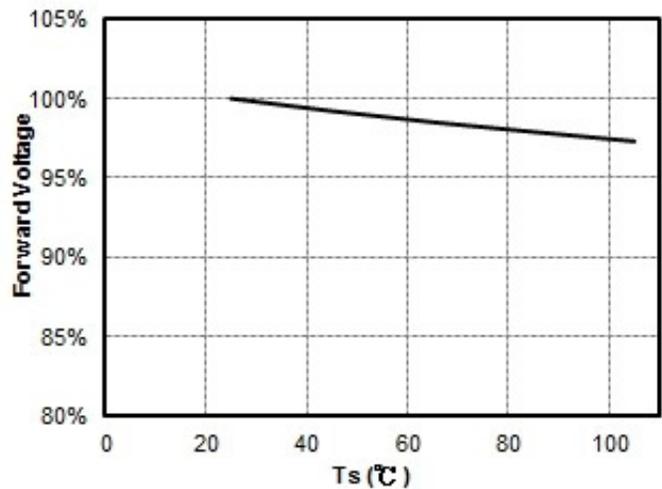
$V_f$ ----- $I_f$



Wavelength- Relative Emission Intensity



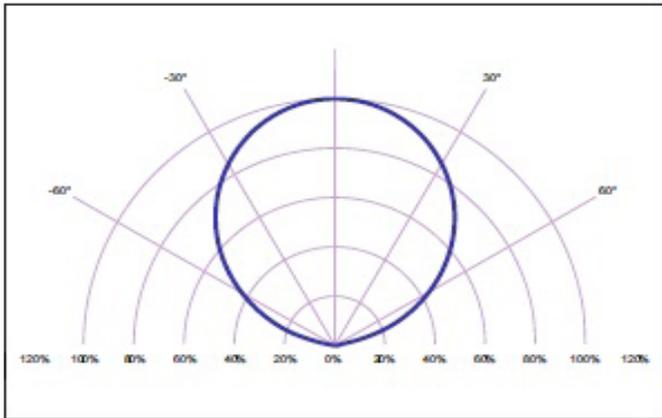
$V_f$  vs. Temperature



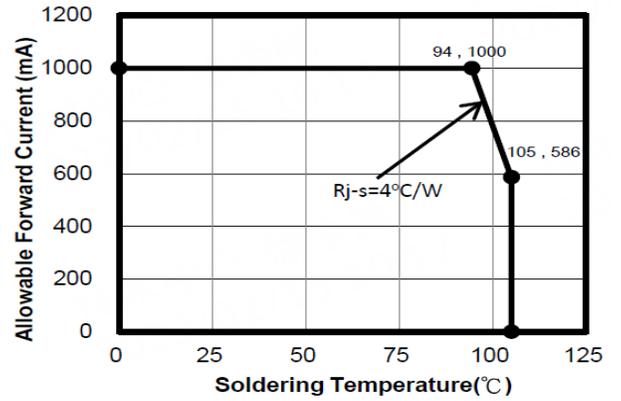
\*Note: Luminus maintains a +/- 0.01 tolerance on chromaticity (CIEx and CIEy) measurements.

Typical Optical/Electrical Characteristics Graphs

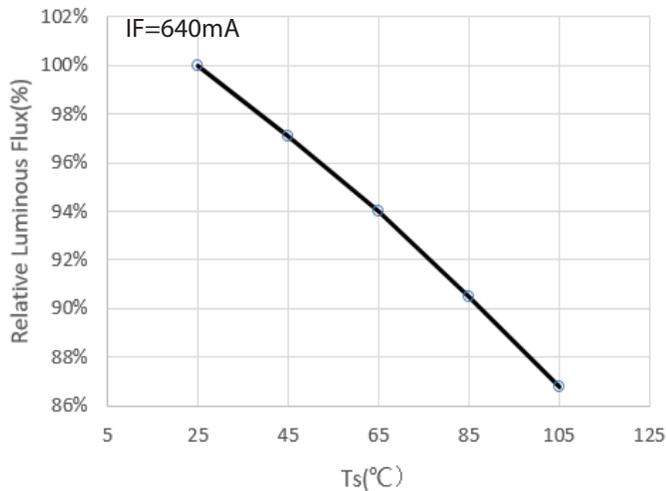
Typical Polar Radiation Pattern



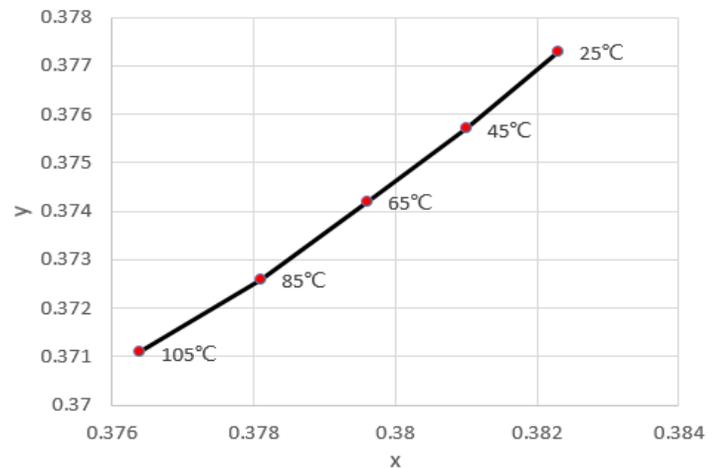
Soldering Temperature- Allowable Forward Current



$T_s$ --Relative Luminous flux



$T_s$  vs. CIE x, y Shift



## Product Ordering and Shipping Part Number Nomenclature

All mid power products are packaged and labeled with part numbers as outlined in below. When shipped, each reel will contain only a single flux and voltage bin. The part number designation is as follows:

### 5050 Mid Power LEDs

Mid Power	Package Type	Package Configurator	Nominal CCT	Minimum CRI
MP	5050	250R	##	##

*Example:*

*The part number MP-5050-250R-30-80 refers to a 5050 mid power emitter with nominal color temperature of 3,000k and minimum CRI of 80. Please refer to page 5 for a description of available CCT and CRI combinations.*

*Note 1: CCT Codes:*

27 = 2700 k  
30 = 3000 k  
40 = 4000 k  
50 = 5000 k  
57 = 5700 k  
65 = 6500 k

*Note 2: CRI Codes:*

70  
80  
90

Each mid power product shipped will be labeled with its specific flux and voltage bins. Not all bins listed are available in all CCTs and CRIs.

### Luminus Flux Bins

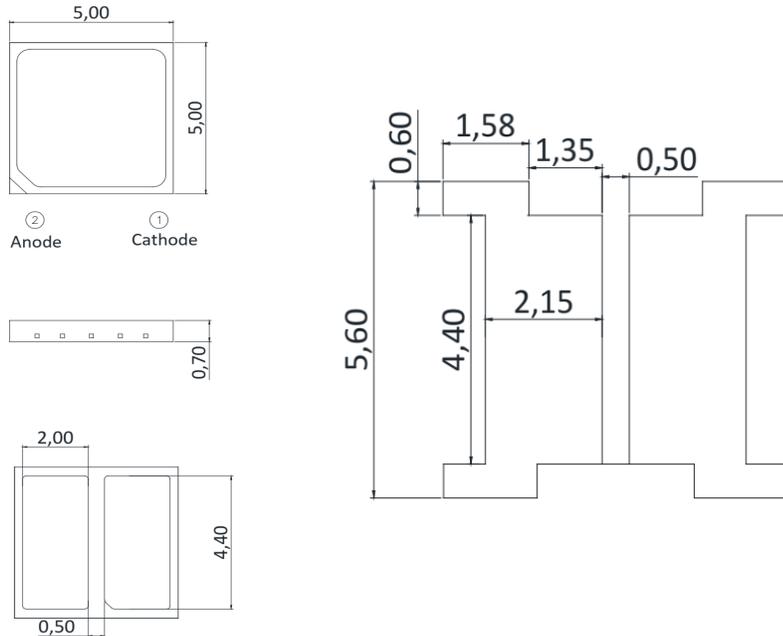
Bin Code	Minimum Flux (Lumens)	Maximum Flux (Lumens)
3B	480	520
3C	520	560
3D	560	600
3E	600	650
3F	650	700
3G	700	800

### Forward Voltage Bins (Ts=25°C)

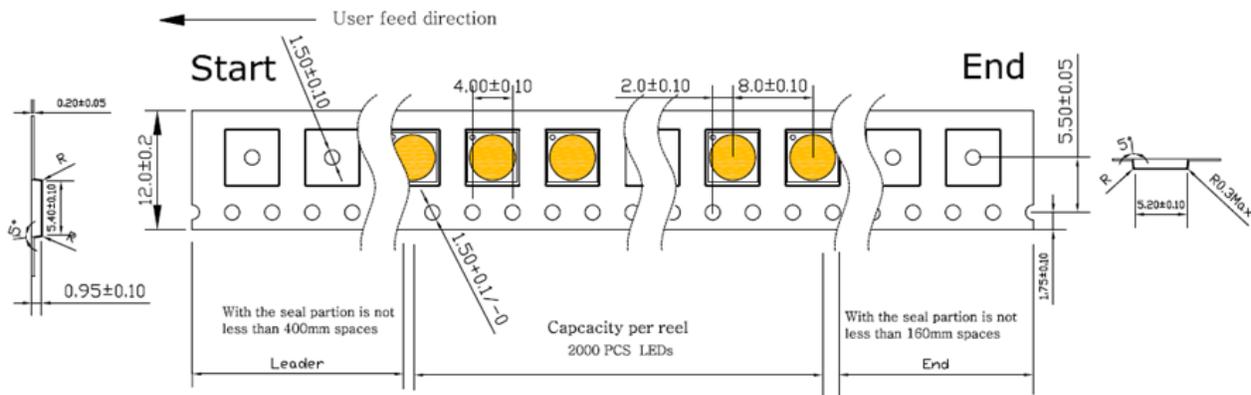
Bin Code	Minimum Voltage (Volts)	Maximum Voltage (Volts)
Z3	5.6	5.8
A4	5.8	6.0
B4	6.0	6.2
C4	6.2	6.4

\*Tolerance of measurements of the Forward Voltage is  $\pm 0.1V$

**Package Dimension and Soldering Pad Pattern (mm)**



**Package Dimensions of Type(mm)**



\*Quantity : Max 2000pcs/Reel

\*Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ±0.2mm

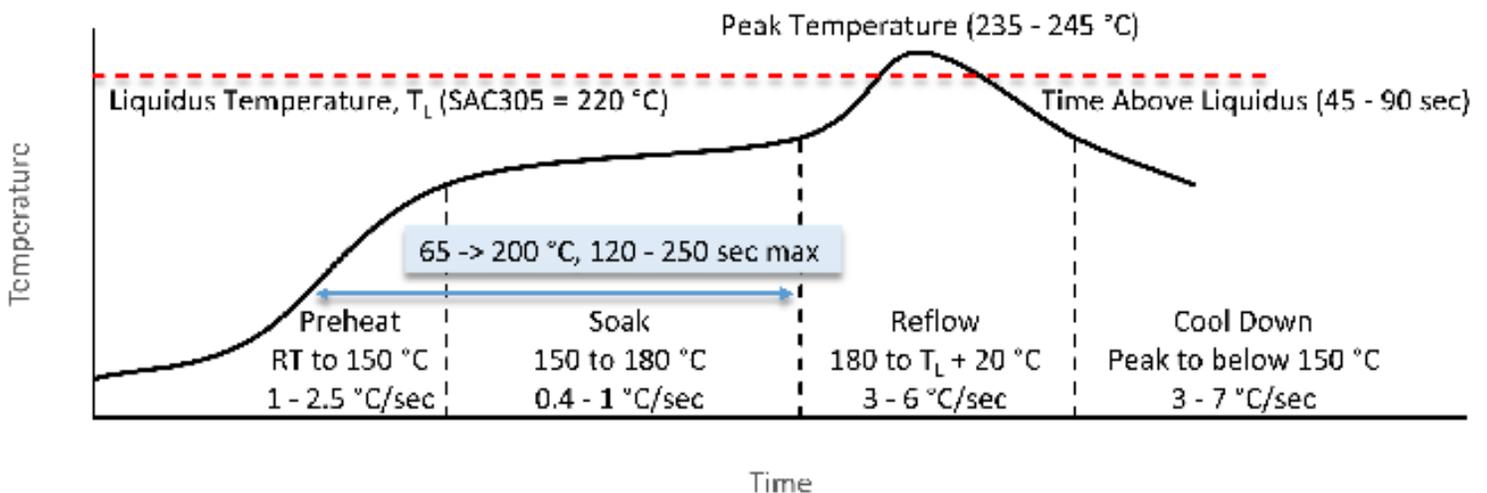
\*Adhesion Strength of Cover Tape Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape.

\*Package : P/N, Manufacturing data Code No. and Quantity to be indicated on a damp proof Package

**Solder Profile**

**Moisture Sensitivity Level**

MSL	3		
Profile Feature	Process Window	Time	Average ramp-up rate
Preheat	65°C - 200°C	120 - 250 sec	1 - 2.5°C/sec
Soak			0.4 - 1°C/sec
Reflow Spike	180°C - $T_L + 20^\circ\text{C}$	N/A	3 - 6°C/sec
Cool Down	$T_p$ to below 150°C	N/A	3 - 7°C/sec
Liquidus Temperature ( $T_L$ )	220°C		
Time Above Liquidus	45 - 90sec		
Peak Temperature	235 - 245°C		
SMT Rework Guideline	Manual Hotplate Reflow	Hot Air Gun Reflow	
Heating Time	< 60 sec		
Hotplate Temperature	< 230°C	< 150°C	



Note 1: The numbers in the table are specific to SAC305. Luminus recommends using an SAC305 solder paste with a no-clean flux for RoHS compliant products.

Note 2: During the pick and place process, axial forces on the dome (or window) should not exceed 0.5 Newtons (N).

Note 3: Use of a multi-zone IR reflow oven with a nitrogen blanket is recommended.

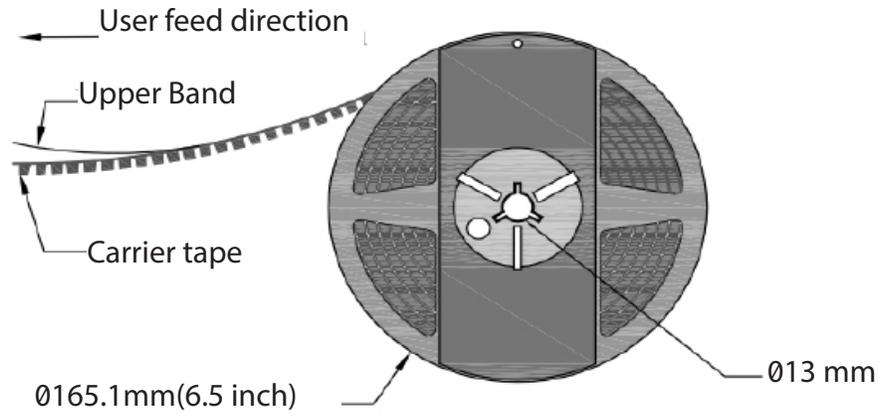
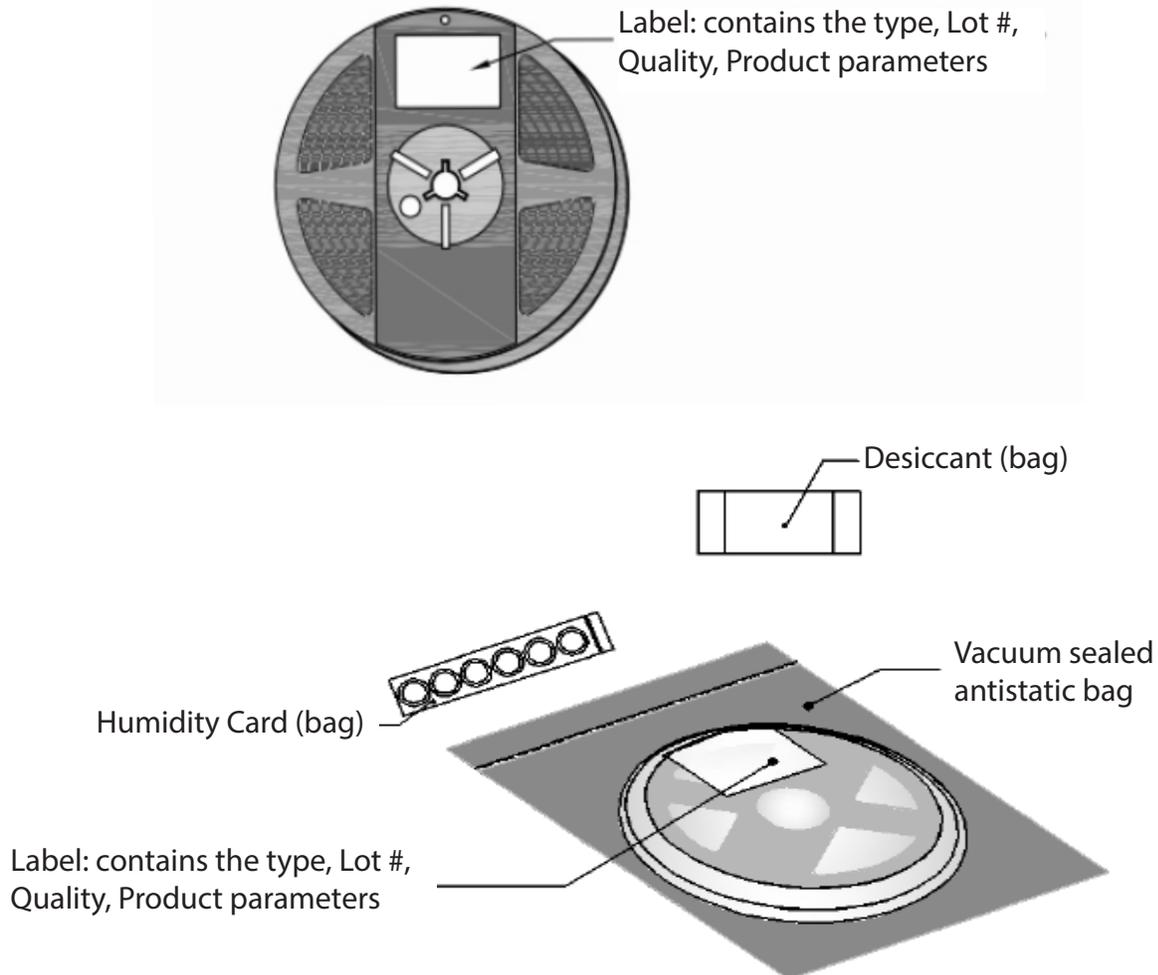
Note 4: Time-temperature profile of the reflow process showing the four functional profile zones are defined in IPC-7801. Temperature is referenced to the center of the PCB.

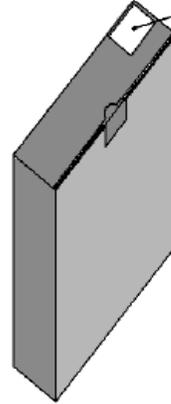
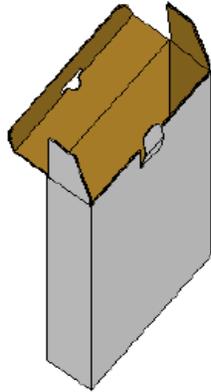
Note 5: Luminus recommends to use the solder paste data sheet information as a starting point in time-temperature process development.

Note 6 These are general guidelines. Consult the solder paste manufacturer's datasheet for guidelines specific to the alloy and flux combination used in your application. Product complies to MSL Level 3. For more information, please refer to:

<https://luminusdevices.zendesk.com/hc/en-us/articles/360060306692-How-do-I-Reflow-Solder-Luminus-SMD-Components->

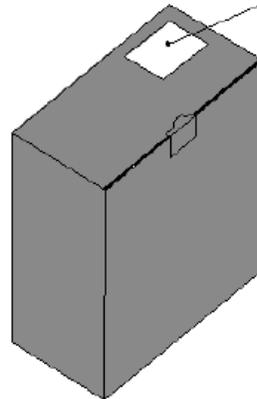
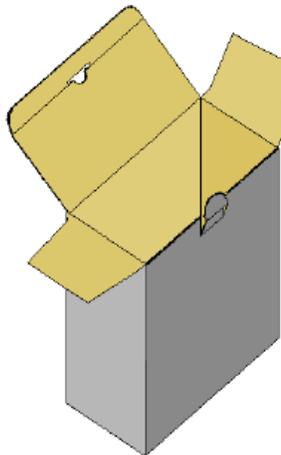
Note 7: For any technical questions about soldering process, please contact Luminus at techsupport@luminus.com.

**Package Dimensions of Reel (mm)**

**Package Dimensions of Reel (mm)**


**Inner Box**


Label: contains the type,  
Lot #, Quality, Product  
parameters

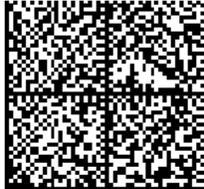
\*Capacity 5 reels per box



Label: contains the type,  
Lot #, Quality, Product  
parameters

\*Capacity 10 reels per box

**Label**

		RoHS Compliant Rev.01	
**_****_****_**_*_****_**			
			
Flux: **	Color: ***		
Voltage: **	CRI: **		
*****			
		QTY: ***	
			

## Precaution for Use

### STORAGE

#### 1.1 Before opening the package

The LEDs should be kept at  $<40^{\circ}\text{C}$  &  $<90\%RH$ . The LEDs should be used within a year. When storing the LEDs, moisture proof package with absorbent material (silica gel) is recommended.

#### 1.2 After opening the package

The LEDs should be kept at  $\leq 30^{\circ}\text{C}$  &  $\leq 60\%RH$ . The LEDs should be soldered within 72 hours (3 days) after opening the moisture proof package.

If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with moisture proof package within absorbent material (silica gel). It is also recommended to return the unused LEDs to the original moisture proof package and to seal the moisture proof package again.

If the moisture absorbent material (silica gel) vapors or expires the expiration date, baking treatment should be performed by using the following conditions :  $60^{\circ}\text{C}$  for 20 hours.

The LEDs electrode and leadframe comprise a silver plated copper alloy. The silver surface may be affected by environments. Please avoid conditions which may cause the LEDs being corroded or discolored. The corrosion or discoloration might lower solderability or affect optical characteristics.

Please avoid rapid transition in ambient temperature, especially in high humidity environments where condensation can occur.

### STATIC ELECTRICITY

The products are sensitive to static electricity and highly taken care when handling them.

Static electricity or surge voltage will damage the LEDs. It is recommended to wear an anti-electrostatic wristband or an anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.